

[54] **COMBINED MOLDED EARPIECE AND SUPPORT FOR LIGHTWEIGHT HEADSETS**

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[\*\*] Term: **14 Years**

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[52] U.S. Cl. .... **D26/14 H**

[58] **Field of Search** ..... **D26/14 H, 14 J; 179/182 R, 182 A, 107 R, 107 E; 128/151, 152**

[56] **References Cited**

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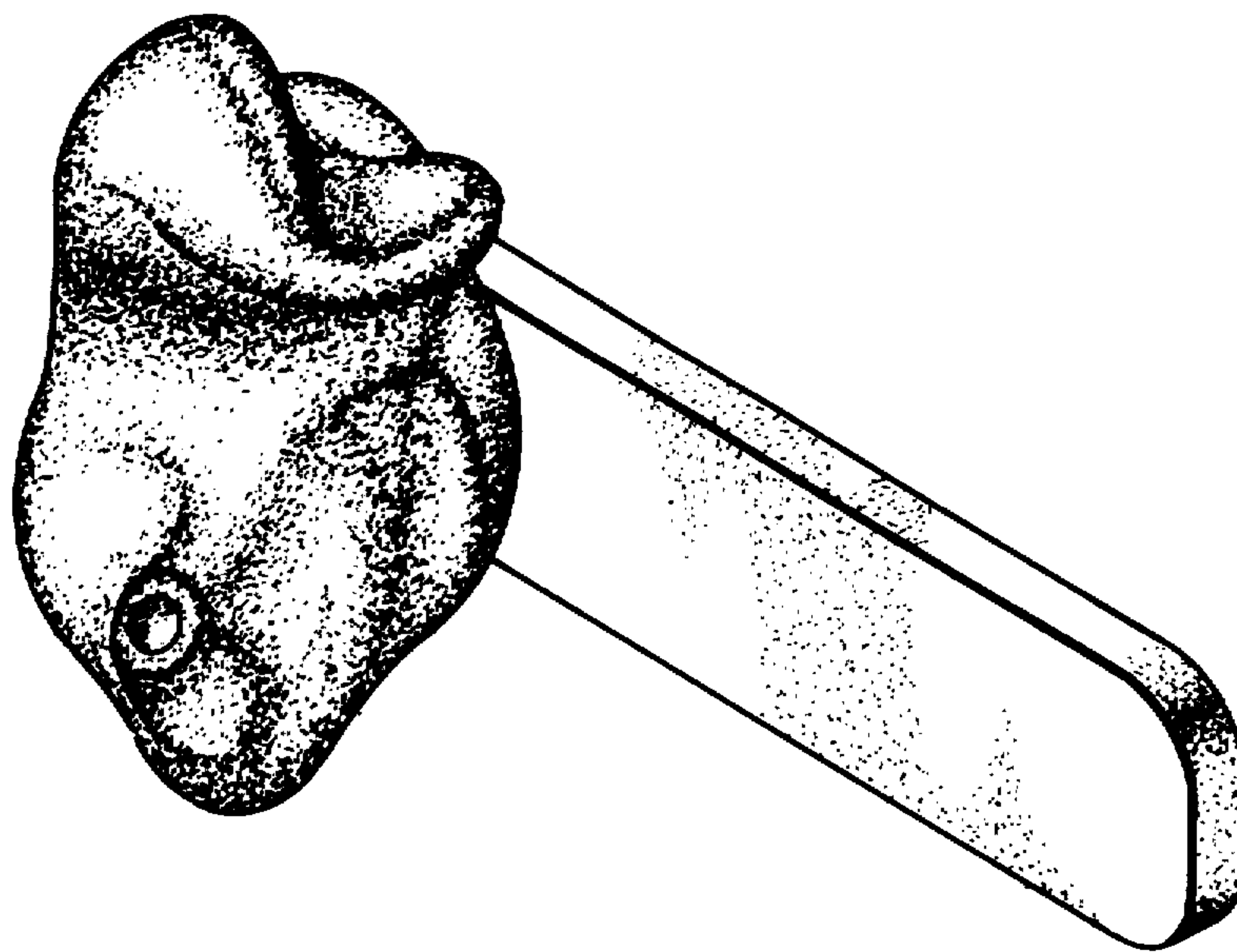
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[57] **CLAIM**

The ornamental design for a combined molded earpiece and support for lightweight headsets, as shown and described.

**DESCRIPTION**

FIG. 1 is a right side perspective view of a combined molded earpiece and support for lightweight headsets showing my new design; FIG. 2 is a rear elevation view thereof; FIG. 3 is a left side elevation view thereof; FIG. 4 is a bottom plan view thereof; and FIG. 5 is a right side perspective view thereof on a reduced scale and in operative relationship relative to a lightweight headset which has been partially shown in broken lines for illustrative purposes only.



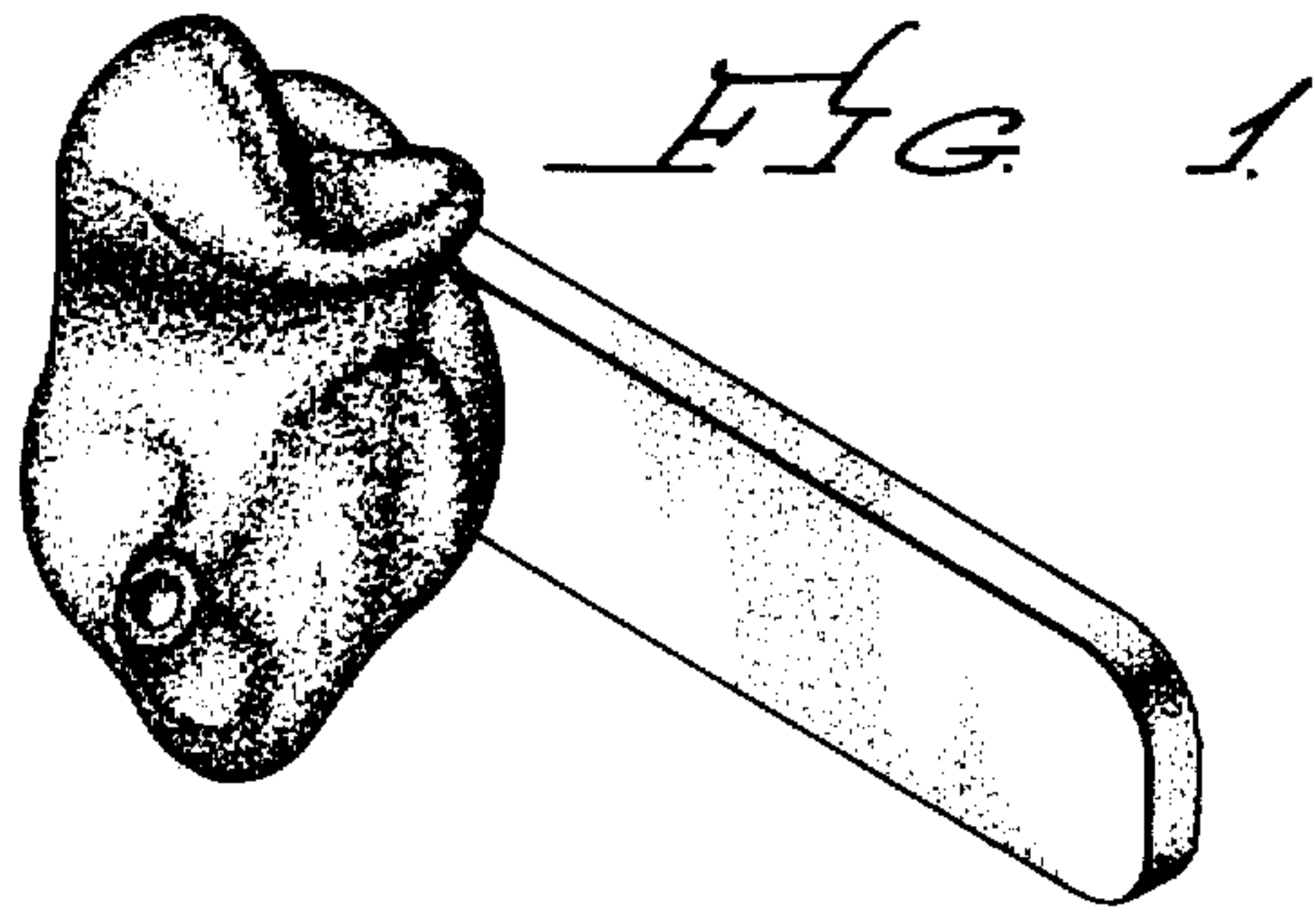


FIG. 3

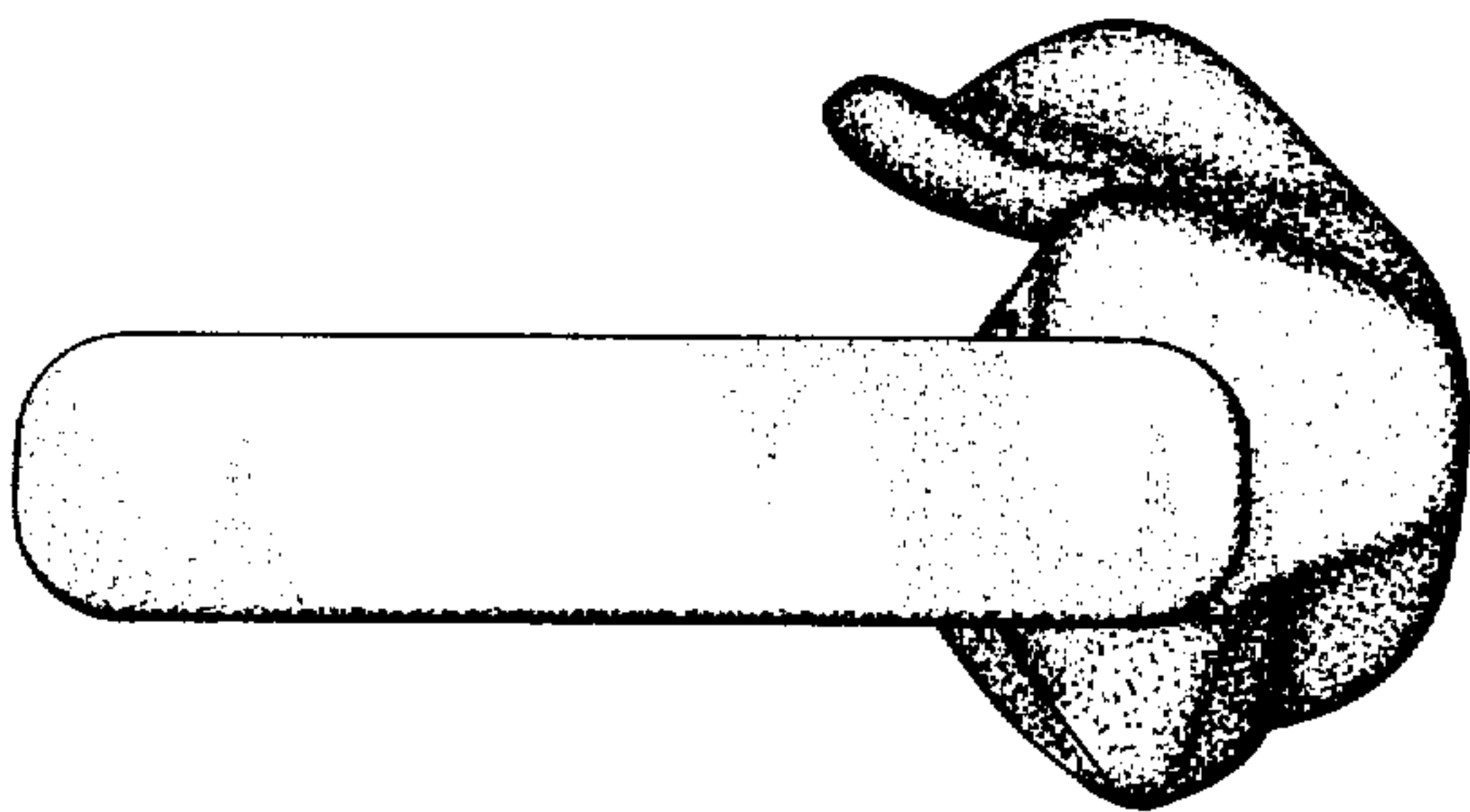


FIG. 2

